

A8N-VM Series Qualified Vendors List (QVL)

Size	Vendor	Chip No.	CL	Chip Brand	SS/DS	Part No.	DIMM socket support (Optional)		
							A*	B*	C*
DDR 400 256MB	KINGSTON	V58C2256804SAT5(ECC)	N/A	N/A	SS	KVR400X72C3A/256		V	
DDR 400 512MB	KINGSTON	V58C2256804SAT5(ECC)	N/A	N/A	DS	KVR400X72C3A/512	V	V	V
DDR 400 512MB	KINGSTON	Heat-Sink Package	N/A	N/A	DS	KHX3200A/512	V	V	V
DDR 400 1024MB	KINGSTON	Heat-Sink Package	N/A	N/A	DS	KHX3200ULK2/1G	V	V	
DDR 400 256MB	KINGSTON	D3208DL3T-5A	N/A	N/A	SS	KVR400X64C3A/256	V	V	V
DDR 400 256MB	KINGSTON	A2S56D30BTP	N/A	N/A	SS	KVR400X64C3A/256	V	V	V
DDR 400 512MB	KINGSTON	V58C2256804SAT5	N/A	N/A	DS	KVR400X64C3A/512	V	V	V
DDR 400 512MB	KINGSTON	HY5DU12822BT-D43	N/A	N/A	SS	KVR400X64C3A/512	V	V	V
DDR 400 1024MB	KINGSTON	HYB25D512800BE-5B	N/A	N/A	DS	KVR400X64C3A/1G	V	V	V
DDR 400 256MB	SAMSUNG	K4H560838E-TCCC(ECC)	N/A	SAMSUNG	SS	M381L3223ETM-CCC	V	V	V
DDR 400 512MB	SAMSUNG	K4H560838E-TCCC(ECC)	N/A	SAMSUNG	DS	M381L6423ETM-CCC	V	V	V
DDR 400 256MB	SAMSUNG	K4H560838E-TCCC	N/A	SAMSUNG	SS	M368L3223ETM-CCC	V		
DDR 400 256MB	SAMSUNG	K4H560838F-TCCC	N/A	SAMSUNG	SS	M368L3223FTN-CCC	V		
DDR 400 512MB	SAMSUNG	K4H560838F-TCCC	N/A	SAMSUNG	DS	M368L6423FTN-CCC	V	V	V
DDR 400 512MB	SAMSUNG	K4H510838B-TCCC	N/A	SAMSUNG	SS	M368L6523BTM-CCC	V	V	
DDR 400 256MB	MICRON	MT46V32M8TG-5BC	N/A	MICRON	SS	MT8VDDT3264AG-40BCB	V	V	V
DDR 400 512MB	MICRON	MT46V32M8TG-5BC	N/A	MICRON	DS	MT16VDDT6464AG-40BCB	V	V	
DDR 400 256MB	Infineon	HYB25D256800CE-5C	3	Infineon	SS	HYS64D32300HU-5-C	V	V	V
DDR 400 512MB	Infineon	HYB25D256800CE-5C	N/A	Infineon	DS	HYS64D64320HU-5-C	V	V	V
DDR 400 256MB	Infineon	HYB25D512160CE-5C	3	Infineon	SS	HYS64D32301HU-5-C	V	V	
DDR 400 512MB	Infineon	HYB25D512800CE-5C	3	Infineon	SS	HYS64D64300HU-5-C	V		
DDR 400 1024MB	Infineon	HYB25D512800CE-5B	3	Infineon	DS	HYS64D128320HU-5-C	V	V	V
DDR 400 256MB	CORSAIR	W942508BH-5	N/A	N/A	SS	CMX256A-3200C2PT	V	V	V
DDR 400 512MB	CORSAIR	Heat-Sink Package	N/A	N/A	DS	CMX512-3200C2	V	V	
DDR 400 512MB	CORSAIR	VS32M8-5	N/A	N/A	DS	VS512MB400	V	V	V
DDR 400 512MB	CORSAIR	Heat-Sink Package	N/A	N/A	DS	CMXP512-3200XL	V	V	
DDR 400 1024MB	CORSAIR	Heat-Sink Package	N/A	N/A	DS	TWINX2048-3200C2	V	V	V
DDR 400 256MB	Hynix	HY5DU56822DT-D43	N/A	N/A	SS	HYMD23264D8J-D43	V	V	V
DDR 400 512MB	Hynix	HY5DU56822DT-D43	N/A	N/A	DS	HYMD26464D8J-D43	V	V	V
DDR 400 256MB	Transcend	K4H560838F-TCCC	3	SAMSUNG	SS	TS32MLD64V4F3	V	V	
DDR 400 512MB	Transcend	K4H560838F-TCCC	3	SAMSUNG	DS	TS64MLD64V4F3	V	V	V
DDR 400 1024MB	Transcend	K4H510838B-TCCC	3	SAMSUNG	DS	TS128MLD64V4J	V	V	
DDR 400 256MB	A DATA	K4H560838E-TCCC	3	SAMSUNG	SS	MDOSS6F3G31Y0K1E0Z	V	V	
DDR 400 512MB	A DATA	K4H560838F-TCCC	3	SAMSUNG	DS	MDOSS6F3H41Y0N1E0Z	V	V	V
DDR 400 256MB	A DATA	HY5DU56822CT-D43	3	Hynix	SS	MDOHY6F3G31Y0N1E0Z	V	V	V
DDR 400 512MB	A DATA	HY5DU56822CT-D43	3	Hynix	DS	MDOHY6F3H41Y0N1E0Z			
DDR 400 256MB	A DATA	ADD8608A8A-5B	2.5	N/A	SS	MDOAD5F3G31Y0D1E02	V	V	
DDR 400 512MB	A DATA	ADD8608A8A-5B	2.5	N/A	DS	MDOAD5F3H41Y0D1E02	V		V
DDR 400 256MB	KINGMAX	KDL388P4LA-50	N/A	N/A	SS	MPXB62D-38KT3R	V	V	V
DDR 400 512MB	KINGMAX	KDL388P4LA-50	N/A	N/A	DS	MPXC22D-38KT3R	V	V	V
DDR 400 256MB	crucial	Heat-Sink Package	2	Ballistix	SS	BL3264Z402.8TG	V	V	V
DDR 400 512MB	crucial	Heat-Sink Package	2	Ballistix	DS	BL6464Z402.16TG		V	

Note:

A* : Supports one module inserted in any slot as Single-channel memory configuration

B* : Supports one pair of modules inserted into either the blue slots or the black slots as one pair of Dual-channel memory configuration

C* : Supports 3 modules inserted into both the blue and black slots as two pairs of Dual-channel memory configuration